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# SP3224E-SP3227E

# 3.0V to 5.5V RS-232 Transceivers with Auto On-Line® Plus

#### **FEATURES**

- 15kV ESD protected RS-232 I/O pins
- Auto On-line<sup>®</sup> Plus automatic power saving mode
- Meets true EIA/TIA-232-F standards from +3.0V to +5.5V power supply.
- Adheres to EIA/TIA-562 for interoperability with EIA/TIA-232 down to a +2.7V supply voltage
- Regulated charge pump yields stable RS-232 outputs
- Drop-in replacement to MAX3224, ICL3224, MAX3225, ICL3225, MAX3226, ICL3226, MAX3227 and ICL3227
- SP3224E and SP3226E reduced EMI with a slew rate controlled 250kbps data rate
- SP3225E and SP3227E- high speed data rate of 1 Mbps.
- Available in RoHS compliant, Lead Free Packaging

READY 1		1
	C1+ 2 V+ 3 C1- 4 C2+ 5 C2- 6 V- 7 T2OUT 8 R2IN 9	 19 Vcc 18 GND 17 T10UT 16 R1IN 15 R10UT 14 ONLINE 13 T1IN

#### **TYPICAL APPLICATIONS**

- Diagnostic/Serial ports on embedded applications
- Handheld Test Equipment
- PC related Peripherals and Equipment
- Battery Powered Equipment
- Point-of-sale Equipment
- Set-top Box

#### DESCRIPTION

The SP3224E/3225E are 2-driver/2-receiver devices and the SP3226E/SP3227E are 1-driver/1-receiver devices. All are ideal for computer peripherals, point-of-sale equipment, consumer and embedded applications. These devices use an internal high-efficiency, charge-pump power supply that requires only 0.1µF capacitors in 3.3V operation. This charge pump and Exar's driver architecture allow it to deliver compliant RS-232 performance from a single power supply ranging from +3.0V to +5.5V. At voltages between 2.7V and 3.0V the driver outputs are compliant with RS-562 and can interface to RS-232 over short cables.

The Auto On-line<sup>®</sup> Plus feature allows the device to automatically "wake-up" during a shutdown state upon detecting activity and to enter a low power shutdown if idle. This power saving feature functions without system intervention or modifications to software or drivers.

#### SELECTION TABLE

All devices feature 3.0V to 5.5V power supply, 4 small charge pump capacitors, and 15kV ESD protection.

Device	Data Rate (bps)	No. of Drivers/Receivers	READY pin	Low-Power Shutdown	Package
SP3224E	250k	2/2	Yes	Auto On-Line® Plus	20 SSOP/TSSOP
SP3225E	1M	2/2	Yes	Auto On-Line® Plus	20 SSOP/TSSOP
SP3226E	250k	1/1	Yes	Auto On-Line <sup>®</sup> Plus	16 SSOP/TSSOP
SP3227E	1M	1/1	Yes	Auto On-Line® Plus	16 SSOP/TSSOP

#### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage (Vcc)0.3V to + 6.0V	
V+ (Note 1)0.3V to + 7.0V	
V- (Note 1)+0.3V to - 7.0V	
V+  +  V- +13V	
Input voltage at TTL input pins0.3V to Vcc+0.3V	
RxIN±16V	
Driver output (from Ground) ±13.2V	
RXOUT, STATUS0.3V to Vcc+0.3V	
Short Circuit Duration, TxOUT to GND,. Continuous	
(One output at a time maximum)	
Storage Temperature65°C to +150°C	;
Operating Temperature SP322XECX0°C to +70°C	
Operating Temperature SP322XEEX40°C to +85°C	
Lead Temperature (soldering, 10s). +300°C	;

Note 1: V+ and V- can have maximum magnitudes of 7V, but their absolute difference cannot exceed 13V.

Maximum junction temperature Thermal Derating, Junction to Ambient	150°C
SSOP20	θJA =83°C/W
TSSOP20	θ <sub>JA</sub> =110.7°C/W
SSOP16	θ <sub>JA</sub> =87°C/W
TSSOP16	θ.ia =100.4°C/W

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

#### ELECTRICAL SPECIFICATIONS

Unless otherwise noted Vcc = +3.0V to +5.5V, Tamb = Tmin to Tmax,. Typical values are at Tamb =  $+25^{\circ}$ C. C1–C4 =  $0.1\mu$ F tested at  $3.3V \pm 10\%$ . C1= $0.047\mu$ F C2–C4 =  $0.33\mu$ F tested at  $5V \pm 10\%$ .

Parameters		Symb	Test Conditions	Min.	Тур.	Max.	Unit
DC Characteristics							
Supply Current, Auto On-Line® Plus		Іссз	Receivers idle, TxIN = Vcc or GND, ONLINE = GND, SHUTDOWN = Vcc Note 2		1	10	μA
Supply Current	, Shutdown	lcc2	SHUTDOWN = GND		1	10	μΑ
Supply Current	, Active	Icc1	ONLINE = SHUTDOWN = Vcc, No Load		1.5	3.0	mA
Supply Current, Active		Icc1	ONLINE = SHUTDOWN = Vcc=3.3V, No Load		0.7	2.0	mA
Driver Input ar	nd Logic Input Pins		2				
	Lliab	ViH	Vcc = 3.3V	2			
Logic Input	High	ViH	Vcc = 5.0V	2.4			
Voltage	Low	VIL				0.8	V
	Logic Threshold	Vт			1.5		
Logic Input Lea	kage Current	lı∟			0.05	±1.0	μΑ
Logic Input Hysteresis		VHYS			100		mV
Receiver Outputs and STATUS Output							
Receiver Output Voltage Low		Vol	IOUT = -1.6mA			0.4	V
Receiver Outpu	ut Voltage High	Vон	Iout = 1mA	Vcc - 0.6			٧

Note 2: Characterized, not 100% tested.

#### **ELECTRICAL SPECIFICATIONS**

Unless otherwise noted Vcc = +3.0V to +5.5V, Tamb = Tmin to Tmax,. Typical values are at Tamb = +25°C. C1–C4 =  $0.1\mu$ F tested at  $3.3V \pm 10\%$ . C1= $0.047\mu$ F C2–C4 =  $0.33\mu$ F tested at  $5V \pm 10\%$ .

Parameters	Symb	Test Conditions	Min.	Тур.	Max.	
Driver Outputs				•		
Output Voltage Swing	Vo	Output load = 3kΩ to GND	±5.0	±6.0		٧
		Output load = Open Circuit	1		±15.0	]
Short Circuit Current		Vout = 0V			±60	mA
Power-Off Impedance		Vcc=V+ = V- = 0 transmitter outputs= ±2V	300	10M		Ω
Output Leakage Current		Vcc = 0 or 3V to 3.3V, Vout = ±12V, Drivers disabled			±25	μA
Receiver Inputs						
Input Voltage Range			-15		15	٧
Input Threshold Low		Vcc = 3.3V	0.6	1.2		V
		Vcc = 5.0V	0.8	1.5		
Input Threshold High		Vcc = 3.3V		1.5	2.4	V
		Vcc = 5.0V		1.8	2.4	
Input Hysteresis				500		mV
Input Resistance			3	5	7	kΩ
ESD Protection						
ESD Protection for R_In, T_Out pins		Human Body Model		±15		kV
All Other Pins		Human Body Model		±2		kV
Auto On-line <sup>®</sup> Plus (ONLINE = GND, SHUTD	OWN = Vcc					
Rx Input Threshold to STATUS output high					±2.7	V
Rx Input Threshold to STATUS output low			±0.3			V
Threshold to STATUS high	tsтн			0.5		μs
Threshold to STATUS low	tstl			30		μs
Rx or Tx transition to drivers enabled	tonline	Note 3		100		μs
Last Rx or Tx transition to drivers disabled	toffline	Note 2, 3	15	30	60	sec

Note 3: A transmitter/receiver edge is defined as a transition through input logic thresholds.

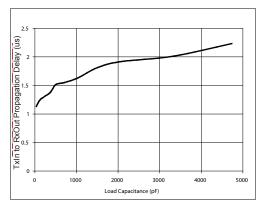
#### TIMING CHARACTERISTICS

Unless otherwise noted Vcc = +3.0V to +5.5V, Tamb = Tmin to Tmax,. Typical values are at Tamb =  $+25^{\circ}$ C. C1–C4 =  $0.1\mu$ F tested at  $3.3V \pm 10\%$ . C1= $0.047\mu$ F C2–C4 =  $0.33\mu$ F tested at  $5V \pm 10\%$ 

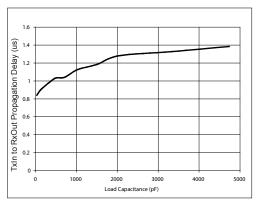
Parameters	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
SP3224E and SP3226E						
Maximum Data Rate		$R_L = 3k\Omega$ , $C_L = 1000pF$ . One transmitter switching.	250			kbps
Transition -Region Slew Rate		Measurement taken from $+3.0V$ to $-3.0V$ or $-3.0V$ to $+3.0V$ , $T_{AMB} = 25$ °C $R_L = 3k\Omega$ to $7k\Omega$ , $C_L = 150pF$ to $1000pF$	4		30	V/µs
Receiver Propagation Delay	t <sub>RPHL</sub> , t <sub>RPLH</sub>	R_IN to R_OUT, C <sub>L</sub> = 150pF		0.22		μs
Receiver Output Enable Time	t <sub>RZH</sub> , t <sub>RZL</sub>	$R_L = 3k\Omega$ , $C_L = 150pF$		0.2	2	μs
Receiver Output Disable Time	t <sub>RHZ</sub> , t <sub>RLZ</sub>			0.2	2	μs
Receiver Skew		t <sub>PHL</sub> - t <sub>PLH</sub>   at 1.5V		200		ns

Parameters	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
SP3225E and SP3227E						
Maximum Data Rate		$R_L$ = 3k $\Omega$ , $C_L$ = 250pF. One transmitter Switching	1000			kbps
Maximum Data Rate		$R_L = 3k\Omega$ , $C_L = 1000pF$ . One transmitter Switching	500			kbps
Instantaneous Slew Rate		Measurement taken from +3.0V to -3.0V or -3.0V to +3.0V, $T_{AMB}=25^{\circ}C$ $R_{L}=3k\Omega \text{ to }7k\Omega,$ $C_{L}=150\text{pF to }250\text{pF}$	24		150	V/µs
Driver Skew	t <sub>DPHL</sub> - t <sub>DPLH</sub>	at zero crossing		75		ns
Receiver Propagation Delay	t <sub>RPHL</sub> , t <sub>RPLH</sub>	R_IN to R_OUT, C <sub>L</sub> = 150pF		0.20		μs
Receiver Output Enable Time	t <sub>RZH</sub> , t <sub>RZL</sub>			0.3	2	μs
Receiver Output Disable Time	t <sub>RHZ</sub> , t <sub>RLZ</sub>			0.2	2	μs
Receiver Skew	t <sub>PHL</sub> - t <sub>PLH</sub>	at 1.5V		80		ns

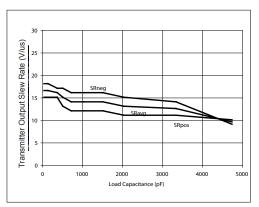
#### -TYPICAL PERFORMANCE CHARACTERISTICS:CURVES



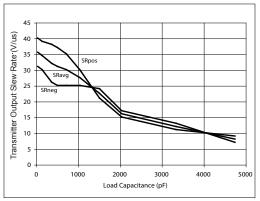
SP3224E/SP3226E Transmitter Input to Receiver Output Propagation Delay vs.
Load Capacitance



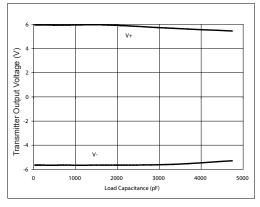
SP3225E/SP3227E Transmitter Input to Receiver Output Propagation Delay vs. Load Capacitance



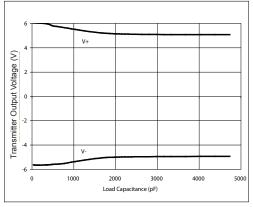
SP3224E/SP3226E Transmitter Output Slew Rate vs. Load Capacitance



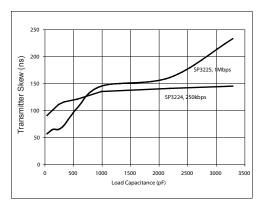
SP3225E/SP3227E Transmitter Output Slew Rate vs. Load Capacitance



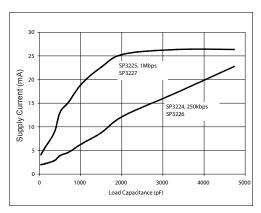
SP3224E/SP3226E Transmitter Output Voltage vs. Load Capacitance



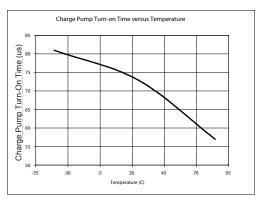
SP3225E/SP3227E Transmitter Output Voltage



Driver Skew vs. Load Capacitance

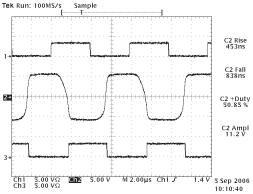


Supply Current vs. Load Capacitance

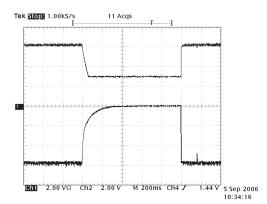


Charge Pump Turn-On Time vs. Temperature

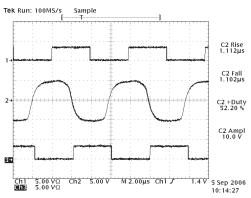
#### -TYPICAL PERFORMANCE CHARACTERISTICS: SCOPE SHOTS



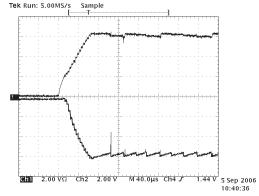
SP3224E/SP3226E Waveforms for 250kbps Clock Rate, RL= $3k\Omega$ , CL=1000pF



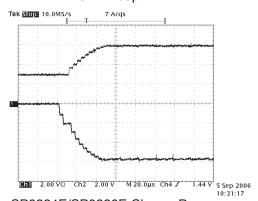
SP3224E/SP3226E Charge Pump Into Shutdown



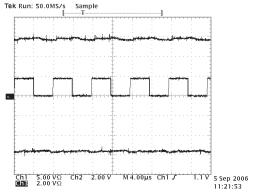
SP3224E/SP3226E Waveforms for 250kbps Clock Rate, RL=3kΩ, CL=4700pF



SP3224E/SP3226E Charge Pump Power On Time, Vcc=3.3V



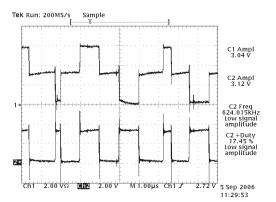
SP3224E/SP3226E Charge Pump Out of Shutdown



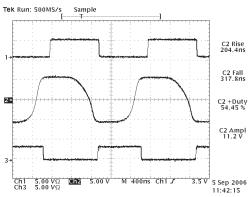
SP3224E/SP3226E Charge Pump Waveforms for 250kbp Clock Rate

All Charge Pump waveforms use charge pump capacitor values C1-C4 =  $0.1\mu$ F

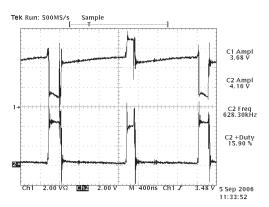
#### -TYPICAL PERFORMANCE CHARACTERISTICS: SCOPE SHOTS



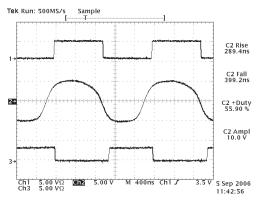
SP3224E/SP3226E C2+ Charge Pump Waveforms, Vcc=3.3V, All Channels switching



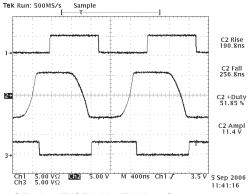
SP3225E/SP3227E Waveforms for 1Mbps Clock Rate, RL=3K $\Omega$ , CL=250pF



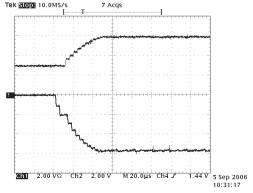
SP3224E/SP3226E C2+ Charge Pump Waveforms, Vcc=5V, All Channels switching



SP3225E/SP3227E Waveforms for 1Mbps Clock Rate, RL=3K $\Omega$ , CL=1000pF



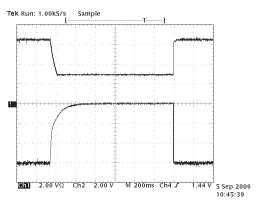
SP3225E/SP3227E Waveforms for 1Mbps Clock Rate, RL= $3K\Omega$ , CL=50pF



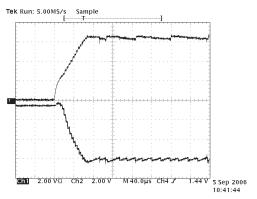
SP3225E/SP3227E Charge Pump Out of Shutdown

All Charge Pump waveforms use charge pump capacitor values C1-C4 =  $0.1\mu$ F

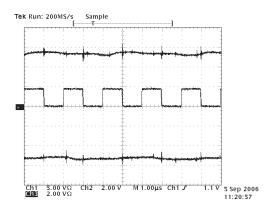
#### TYPICAL PERFORMANCE CHARACTERISTICS



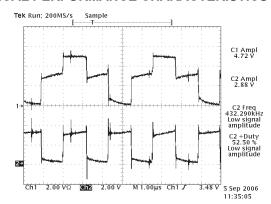
SP3225E/SP3227E Charge Pump Into Shutdown



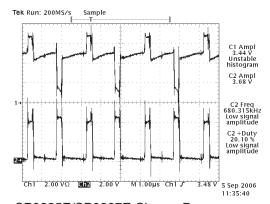
SP3225E/SP3227E Charge Pump Power On Time, Vcc=3.3V



SP3225E/SP3227E Charge Pump Waveforms for 1Mbps Clock Rate



SP3225E/SP3227E Charge Pump Waveforms, Vcc=3.3V, All Channel Switching



SP3225E/SP3227E Charge Pump Waveforms, Vcc=5V, All Channel Switching

All Charge Pump waveforms use charge pump capacitor values C1-C4 = 0.1µF

#### CHARACTERIZATION CIRCUITS AND WAVEFORMS

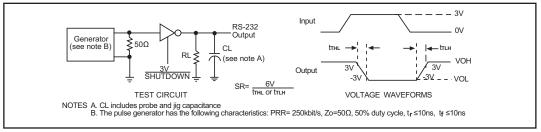


Figure 1. Driver Slew Rate

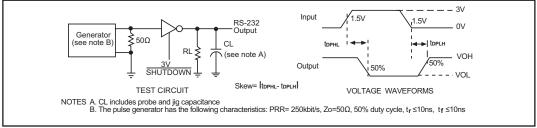


Figure 2. Driver Propagation and Skew

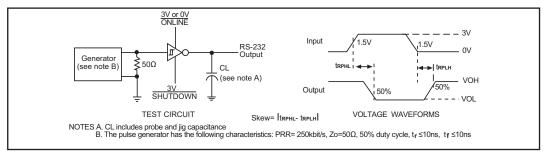


Figure 3. Receiver Propagation Delay and Skew

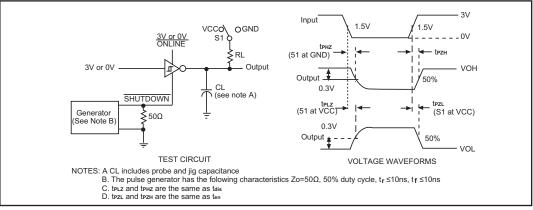


Figure 4. Receiver Enable and Disable Times

#### THEORY OF OPERATION

## Description

The SP3224E and SP3225E are 2-driver/2-receiver devices. The SP3226E and SP3227E are 1-driver/1-receiver devices. All are ideal for serial ports in embedded, consumer, portable, or handheld applications. The transceivers meet the EIA/TIA-232 and ITU-T V.28/V.24 communication protocols for reliable serial communication. The devices feature Exar's proprietary and patented (U.S. 5,306,954) on-board charge pump circuitry that generates ±5.5V RS-232 voltage levels from a single +3.0V to +5.5V power supply.

The SP3224E-SP3227E are ideal choices for power sensitive designs. With the Auto On-line Plus enabled, the SP3224E-SP3227E reduce supply current to  $1\mu$ A whenever the transceivers are in idle. In shutdown, the internal charge pump and the drivers will shut down. This feature allows design engineers to address power saving concerns without major design changes.

## **Theory Of Operation**

The SP3224E-SP3227E are made up of four basic circuit blocks: 1. Drivers, 2. Receivers, 3. the Exar proprietary charge pump, and 4. Auto On-line® Plus circuitry.

#### **Drivers**

The drivers are inverting level transmitters that convert TTL or CMOS logic levels to 5.0V EIA/TIA-232 levels with an inverted sense relative to the input logic levels. Typically, the RS-232 output voltage swing is +5.4V with no load and +5V minimum fully loaded. The driver outputs are protected against infinite short-circuits to ground without degradation in reliability. These drivers comply with the EIA-TIA-232-F and all previous RS-232 versions. Unused driver inputs should be connected to GND or VCC.

The drivers can guarantee output data

rates fully loaded with  $3K\Omega$  in parallel with 1000pF (SP3224E/SP3226E), or  $3K\Omega$  in parallel with 250pF (SP3225E/SP3227E) ensuring compatibility with PC-to-PC communication software. The slew rate of the driver output on the SP3224E/SP3226E is internally limited to a maximum of  $30V/\mu s$  in order to meet the EIA standards (EIA RS-232D 2.1.7, Paragraph 5). The Slew Rate of SP3225E/SP3227E is not limited to enable higher speed data transfers. The transition of the loaded output from HIGH to LOW also meets the monotonic signal transition requirements of the standard.

#### Receivers

The receivers convert EIA/TIA-232 signal levels to TTL or CMOS logic output levels. Receivers remain active during device shutdown. Since receiver input is usually from a transmission line where long cable lengths and system interference can degrade the signal, the inputs have a typical hysteresis margin of 500mV. This ensures that the receiver is virtually immune to noisy transmission lines. Should an input be left unconnected, an internal  $5K\Omega$  pulldown resistor to ground will commit the output of the receiver to a HIGH state.

# **Charge Pump**

The charge pump is a Exar–patented design (US Patent #5,306,954) and uses a unique approach compared to older less-efficient designs. The charge pump still requires four external capacitors, but uses a four phase voltage shifting technique to attain symmetrical 5.5V power supplies. The internal power supply consists of a regulated dual charge pump that provides output voltages 5.5V regardless of the input voltage (Vcc) over the +3.0V to +5.5V range. This is important to maintain compliant RS-232 levels regardless of power supply fluctuations.

The charge pump operates in a discontinuous mode using an internal oscillator. If the output voltages are less than a magnitude

of 5.5V, the charge pump is enabled. If the output voltages exceed a magnitude of 5.5V, the charge pump is disabled. This oscillator controls the four phases of the voltage shifting. A description of each phase follows.

### **Highly Efficient Charge Pump**

The charge pump is used to generate positive and negative signal voltages for the RS-232 drivers. This enables fully compliant RS-232 and V.28 signals from a single 3.0 or 5.5V power supply.

The charge pumps use four external capacitors to hold and transfer electrical charge. The Exar patented design (US Patent #5,306,954) uses a unique approach compared to older less efficient designs. The pumps use a four–phase voltage shifting technique to attain symmetrical V+ and V-power supplies. An intelligent control oscillator regulates the operation of the charge pump to maintain the proper voltages at maximum efficiency.

#### Phase 1

Vss charge store and double: The positive terminals of capacitors C1 and C2 are charged from Vcc with their negative terminals initially connected to ground. C1+ is then connected to ground and the stored charge from C1– is superimposed onto C2–. Since C2+ is still connected to Vcc the voltage potential across capacitor C2 is now 2 x Vcc.

#### Phase 2

Vss transfer and invert: Phase two connects the negative terminal of C2 to the Vss storage capacitor and the positive terminal of C2 to ground. This transfers the doubled and inverted (V–) voltage onto C4. Meanwhile, capacitor C1 charged from Vcc to prepare it for its next phase.

#### Phase 3

VDD charge store and double: Phase three

is identical to the first phase. The positive terminals of capacitors C1 and C2 are charged from Vcc with their negative terminals initially connected to ground. C1+ is then connected to ground and the stored charge from C1– is superimposed onto C2–. Since C2+ is still connected to Vcc the voltage potential across capacitor C2 is now 2 x Vcc.

#### Phase 4

VDD transfer: The fourth phase connects the negative terminal of C2 to ground and the positive terminal of C2 to the VDD storage capacitor. This transfers the doubled (V+) voltage onto C3. Meanwhile, capacitor C1 charged from Vcc to prepare it for its next phase.

The Exar charge pump generates V+ and V- independently from Vcc. Hence in a noload condition V+ and V- will be symmetrical. Older charge pump approaches generate V+ and then use part of that stored charge to generate V-. Because of inherent losses the magnitude of V- will be smaller than V+ on these older designs.

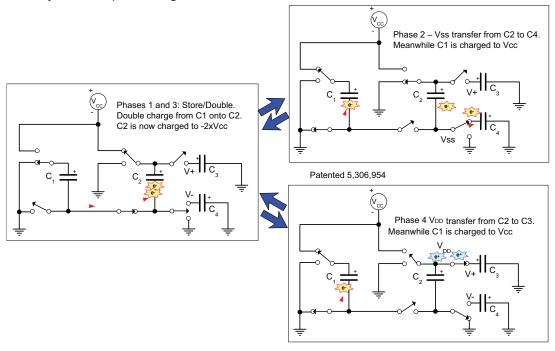
Under lightly loaded conditions the intelligent pump oscillator maximizes efficiency by running only as needed to maintain V+ and V-. Since interface transceivers often spend much of their time at idle this power-efficient innovation can greatly reduce total power consumption. This improvement is made possible by the independent phase sequence of the Exar charge pump design.

The clock rate for the charge pump typically operates at greater than 70kHz allowing the pump to run efficiently with small 0.1µF capacitors. Efficient operation depends on rapidly charging and discharging C1 and C2, therefore capacitors should be mounted close to the IC and have low ESR (equivalent series resistance). Inexpensive surface mount ceramic capacitors (such as

are widely used for power-supply decoupling) are ideal for use on the charge pump. The charge pumps are designed to be able to function properly with a wide range of capacitor styles and values. If polarized capacitors are used the positive and negative terminals should be connected as shown on the Typical Operating Circuit.

Capacitance values may be increased if operating at higher Vcc or to provide greater stability as the capacitors age.

The SP3224E-SP3227E devices have the advanced Auto On-Line Plus feature RS-232 signals use both positive and negative voltages of greater than  $\pm 5V$  magnitude. Receivers have nominal  $5k\Omega$  impedance to ground. Even when idle, drivers will maintain output signal voltage creating a continuous current flow. In low power, battery operated devices this constant current drain can decrease battery life significantly.



Charge Pump Phases

Minimum Recommended Charge Pump Capacitor Values					
Input Voltage Vcc	Charge Pump Capacitor Value for SP32XX				
3.0V to 3.6V	C1-C4=0.1µF				
4.5V to 5.5V	C1=0.047µF, C2-C4=0.33µF				
3.0V to 5.5V	C1-C4=0.22µF				

Charge Pump Capacitor Values

that saves power by turning off the charge pumps and driver outputs when the transceiver inputs are idle for more than 30 seconds. Auto On-line® Plus is equivalent to Maxim's "Auto Shutdown Plus" feature. It differs from our existing Auto On-line® by relying on signal transitions rather than voltage levels to trigger shutdown and wakeup.

Auto On-Line® Plus automatically puts the device into a standby mode where it draws only 1µA typical. When the device detects activity on either the receiver or driver inputs it will automatically awake and activate to allow serial communication. Both the wakeup and shutdown happen automati-

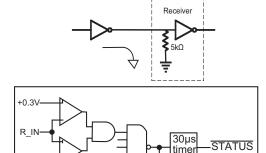


Figure 3a. STATUS Functional Diagram STATUS low

INVALID ASSERTED IF ALL RECEIVER INPUTS ARE BETWEEN +0.3V AND -0.3V FOR AT LEAST 30µS

-0.3\/

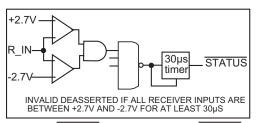


Figure 3b. STATUS Functional Diagram, STATUS high. Figure 3d. Powerdown Logic cally, without any user intervention, special drivers, or software modifications.

Wakeup and shutdown can be externally controlled by the ONLINE and SHUTDOWN pins. When ONLINE is driven to logic LOW, the Auto On-line® Plus function is active. Driving SHUTDOWN to

logic LOW forces the device into shutdown state regardless of input activity or the status of the ONLINE pin.

The STATUS output determines whether a valid RS-232 signal voltage is present on the inputs. The STATUS pin goes to a logic LOW when the receiver input signal levels collapse near reference ground. This may occur when the RS-232 cable is disconnected or the RS-232 drivers of the connected peripheral are turned off.

STATUS may be used to indicate DTR or a Ring Indicator signal or to determine whether a live RS232 driver or cable is connected. By connecting the STATUS output to ONLINE input, the SP3224E-SP3227E will shut down when no valid signal level and no input transitions are detected, and wake up on a valid signal level or signal edge. If it detects no signal transitions with the past 30

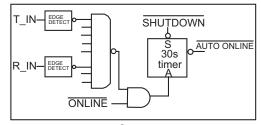
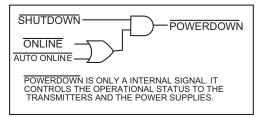


Figure 3c. Auto On-line Plus Logic



seconds, the device will go into low power mode. By connecting the STATUS output to both the ONLINE input and SHUTDOWN input pins, the device enters into shutdown when not receiving a valid RS-232 signal voltage input.

When the SP3224E-SP3227E devices are

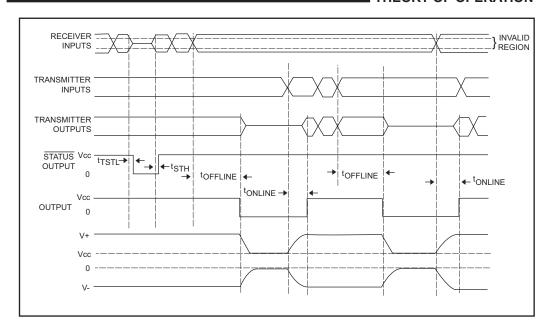
shut down, the charge pumps are turned off. V+ charge pump output decays to VCC, the V- output decays to GND. The decay time will depend on the size of capacitors used for the charge pump. Once in shutdown, the time required to exit the shutdown state and have valid V+ and V- levels is typically  $50\mu s$ . When the SP3224E-SP3227E drivers and internal charge pump are disabled, the supply current is reduced to  $1\mu A$ .

Auto On-Line (existing)	Device enters low-power mode if receiver inputs see less than valid +/- 3V.
	STATUS (or INVALID) signal output indicates if valid signal voltage is at receivers.
Auto On-Line Plus (new)	Device enters low-power mode if driver inputs or receiver inputs see no transitions for 30 seconds. Return to full power mode upon any transition on any driver input or receiver input
	Shutdown occurs even if data cable is connected to an active driver, as long as all inputs remain unchanged
	STATUS (or INVALID) signal functions as before. Indicates if valid signal voltage is present. But has no effect on shutdown
	For SP3224E the $\overline{\text{EN}}$ input is replaced with a READY output. READY drives high when charge pump achieves greater than -4V Vss (V-). Indicates "ready to transmit."

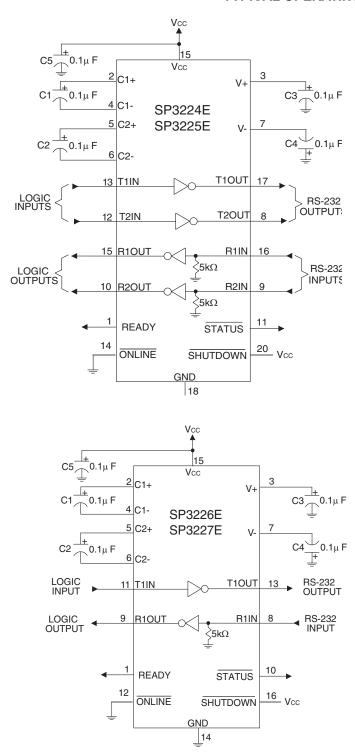
# Comparison of Auto On-line® Features

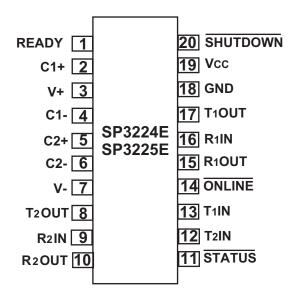
Operating Mode	ONLINE	SHDN	Rin  > ±2.7V	Idle Inputs (RxIN & TXIN)	Тхоит	Rxоuт
Forced Shutdown	Х	0	Х	Х	Hi-Z	Active
Forced On-Line	1	1	Х	Х	Active	Active
Auto On-Line Plus (Wake when active)	0	1	Х	Active	Active	Active
Auto On Line Plus (Off-Line when idle)	0	1	Х	Idle > 30s	Hi-Z	Active
Auto On-Line Plus (Wake on cable)	STATUS	1	Yes	Х	Active	Active
Auto On-Line Plus (Wake when active)	STATUS	1	No	Active	Active	Active
Auto On-Line Plus (Off-Line when idle)	STATUS	1	No	Idle > 30s	Hi-Z	Active
Auto On-Line (Wake on cable)	STATUS	STATUS	Yes	Х	Active	Active
Auto On-Line (Auto Shutoff)	STATUS	STATUS	No	Х	Hi-Z	Active

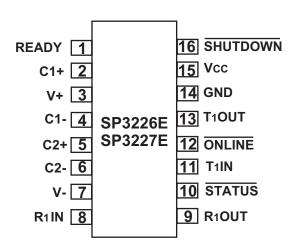
Auto On-line® Plus Truth Table

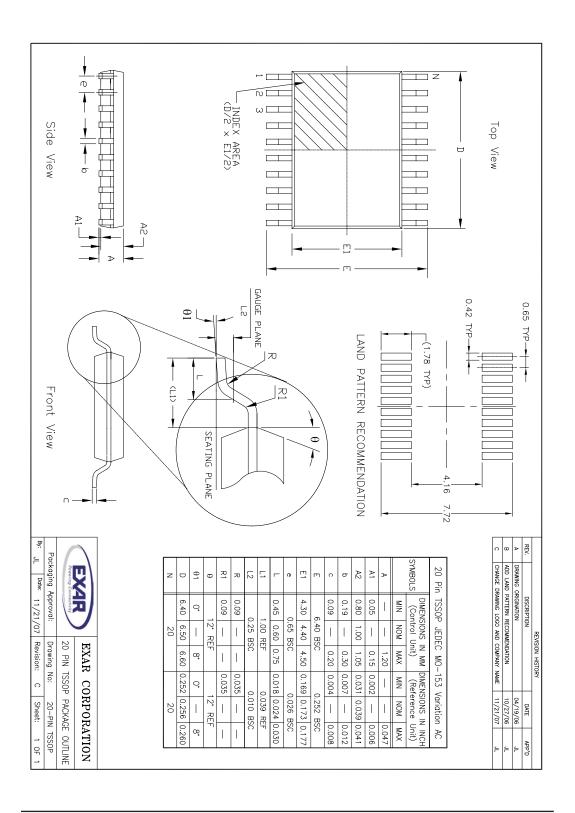


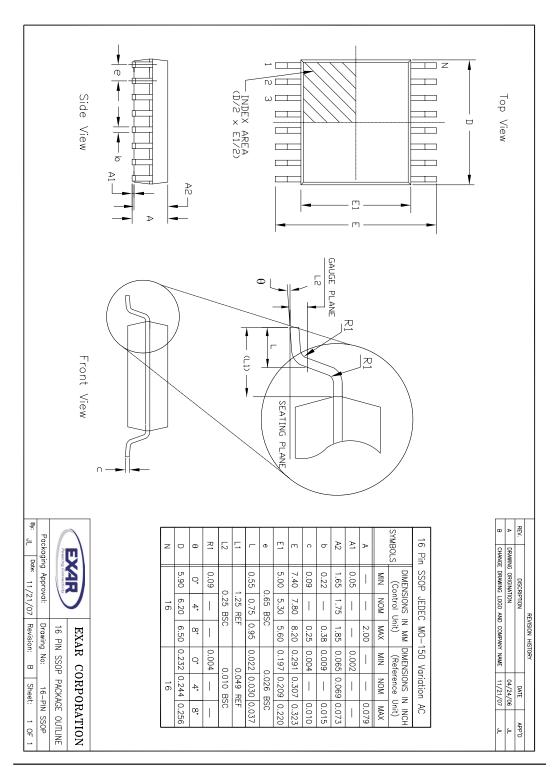
Auto On-Line® Plus Timing Diagram tstl (=30µs typ.) tsth (=0.4µs typ.) toffline (=30s typ.) tonline (=100µs typ.)

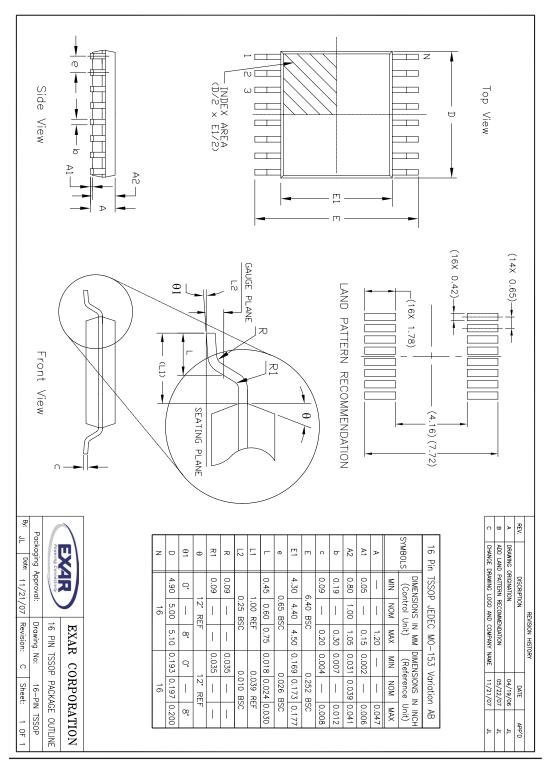


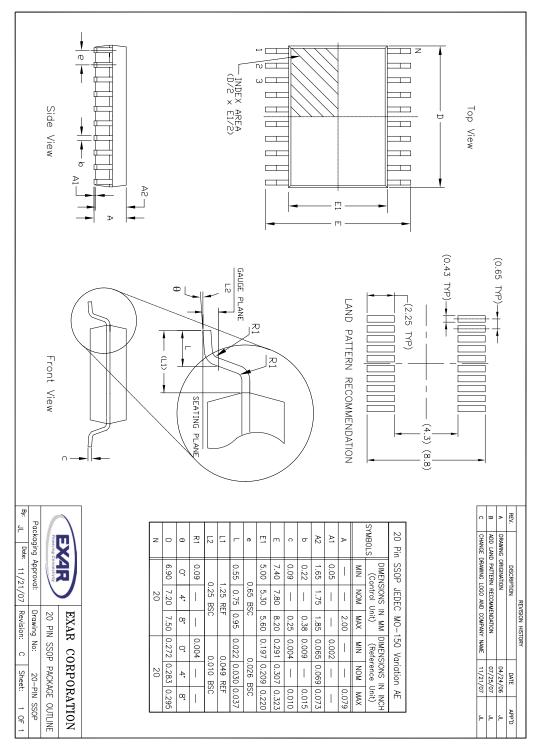












Part number	Temperature range	Package Type
SP3224ECA-L	From 0°C to +70°C	Lead Free 20 pin SSOP
SP3224ECY-L	From 0°C to +70°C	Lead Free 20 pin TSSOP
SP3224EEA-L	From -40°C to +85°C	Lead Free 20 pin SSOP
SP3224EEY-L	From -40°C to +85°C	Lead Free 20 pin TSSOP
SP3225ECA-L	From 0°C to +70°C	Lead Free 20 pin SSOP
SP3225ECY-L	From 0°C to +70°C	Lead Free 20 pin TSSOP
SP3225EEA-L	From -40°C to +85°C	Lead Free 20 pin SSOP
SP3225EEY-L	From -40°C to +85°C	Lead Free 20 pin TSSOP
SP3226ECA-L	From 0°C to +70°C	Lead Free 16 pin SSOP
SP3226ECY-L	From 0°C to +70°C	Lead Free 16 PIN SSOP
SP3226EEA-L	From -40°C to +85°C	Lead Free 16 pin SSOP
SP3226EEY-L	From -40°C to +85°C	Lead Free 16 PIN TSSOP
SP3227ECA-L	From 0°C to +70°C	Lead Free 16 PIN SSOP
SP3227ECY-L	From 0°C to +70°C	Lead Free 16 PIN TSSOP
SP3227EEA-L	From -40°C to +85°C	Lead Free 16 PIN SSOP
SP3227EEY-L	From -40°C to +85°C	Lead Free 16 PIN TSSOP

### Available in Tape on Reel

DATE	REVISION	DESCRIPTION
11-20-06	Р	Legacy Sipex Datasheet
12-14-09	1.0.0	Update to Exar Format. Change revision to 1.0.0. Change Supply Current Active over full Vcc range maximum from 2.0mA to 3.0mA. Change Supply Current Active at Vcc = 3.3V maximum from 1.0mA to 2.0mA. Change RX input voltage ABS Maximum Rating from +/-18V to +/-16V.
08-17-11	1.0.1	Correct type error on front page Features list.

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